THERMAL DATA

R _{thj-case}	Thermal Resistance Junction-Case	Max	83.3	°C/W
R _{thj-Amb}	Thermal Resistance Junction-Ambient	Мах	200	°C/W

ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \ ^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
ICES	Collector Cut-off Current (V _{BE} = 0)	V _{CE} = -500V V _{CE} = -500V	T _j = 125°C			-1 -5	mA mA
V _{(BR)EBO}	Emitter Base Breakdown Voltage (I _C = 0)	I _E = -10 mA		-5		-10	V
V _{CEO(sus)} *	Collector-Emitter Sustaining Voltage (I _B = 0)	I _C = -10 mA L = 25 mH		-400			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = -0.5 A I _C = -0.35 A	I _B = -0.1 A I _B = -50 mA			-0.5 -0.5	V V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	I _C = -0.5 A	I _B = -0.1 A			-1	V
h _{FE} *	DC Current Gain	I _C = -10 mA I _C = -0.35 A I _C = -1 A	V _{CE} = -5 V V _{CE} = -5 V V _{CE} = -5 V	10 16 4	25	32	
tr ts t _f	RESISTIVE LOAD Rise Time Storage Time Fall Time	$I_{C} = -0.35 \text{ A}$ $I_{B1} = -70 \text{ mA}$ $T_{p} \ge 25 \mu \text{s}$	V _{CC} = 125 V I _{B2} = 70 mA (see Figure 2)	1.5	90 2.2 0.1	2.9	ns μs μs
t _s t _f	INDUCTIVE LOAD Storage Time Fall Time	$ I_C = -0.5 \text{ A} \\ V_{\text{BE(off)}} = 5 \text{ V} \\ V_{\text{clamp}} = 300 \text{ V} $	I _{B1} = -0.1 A L = 10 mH (see Figure 1)		400 40		ns ns
Esb	Avalanche Energy	L = 4 mH I _{BR} ≤ 2.5 A 2	C = 1.8 nF 25°C < T _C < 125°C	12			mJ

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* Pulsed: Pulse duration = 300μs, duty cycle = 1.5 %.

Safe Operating Area



DC Current Gain



Collector Emitter Saturation Voltage



Derating Curve



DC Current Gain







Resistive Load Fall Time



Inductive Load Fall Time



Reverse Biased SOA



Resistive Load Storage Time



Inductive Load Storage Time



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Figure 2: Resistive Load Switching Test Circuit.





ЫМ	mm		inch				
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	4.32		4.95	0.170		0.195	
b	0.36		0.51	0.014		0.020	
D	4.45		4.95	0.175		0.194	
E	3.30		3.94	0.130		0.155	
е	2.41		2.67	0.095		0.105	
e1	1.14		1.40	0.045		0.055	
L	12.70		15.49	0.500		0.609	
R	2.16		2.41	0.085		0.094	
S1	1.14		1.52	0.045		0.059	
W	0.41		0.56	0.016		0.022	
V	4 degree		6 degree	4 degree		6 degree	





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